



TE Internal #: 2229339-1

TE Internal Description: ILM ASSY WITH COVER, NARROW, LGA2011-3

LGA 2011 Hardware: ILM Assembly

[View on TE.com >](#)

Connectors > Socket Connectors > IC & Component Socket Accessories > IC Socket Hardware > LGA 2011 Hardware: ILM Assembly



Compatible With IC Socket Type: LGA 2011

Card & Socket Accessory Type: ILM Assembly

Operating Temperature Range: -25 – 100 °C [-13 – 212 °F]

[All LGA 2011 Hardware: ILM Assembly \(0\)](#)

Features

Product Type Features

Socket Connector Accessory Type	Accessory
Card & Socket Accessory Type	ILM Assembly

Body Features

Spring Plate Assembly Material	Stainless Steel
Top Support Plate Material	Stainless Steel

Contact Features

Compatible With IC Socket Type	LGA 2011
--------------------------------	----------

Usage Conditions

Operating Temperature Range	-25 – 100 °C [-13 – 212 °F]
-----------------------------	-------------------------------

Packaging Features

Packaging Method	Box & Tray, Tray
------------------	------------------

Product Compliance

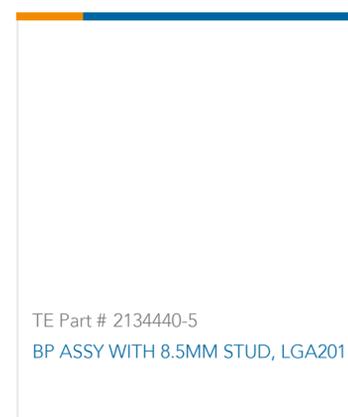
[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2020 (205) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



Documents

Product Drawings

ILM ASSY WITH COVER, NARROW, LGA2011-3

English

CAD Files

3D PDF

3D

Customer View Model



[ENG_CVM_CVM_2229339-1_A.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2229339-1_A.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2229339-1_A.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.